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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/674,017	09/30/2003	Myoung-Kee Baek	8734.240.00 US	2379
30827	7590	04/04/2011	EXAMINER	
MCKENNA LONG & ALDRIDGE LLP 1900 K STREET, NW WASHINGTON, DC 20006				TALBOT, BRIAN K
ART UNIT		PAPER NUMBER		
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**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

<b>Office Action Summary</b>	<b>Application No.</b>	<b>Applicant(s)</b>	
	10/674,017	BAEK ET AL.	
	<b>Examiner</b>	<b>Art Unit</b>	
	Brian K. Talbot	1715	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

#### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

#### Status

- 1) Responsive to communication(s) filed on 08 March 2011.  
 2a) This action is **FINAL**.                    2b) This action is non-final.  
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

#### Disposition of Claims

- 4) Claim(s) 12, 18 and 19 is/are pending in the application.  
 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.  
 5) Claim(s) \_\_\_\_\_ is/are allowed.  
 6) Claim(s) 12, 18 and 19 is/are rejected.  
 7) Claim(s) \_\_\_\_\_ is/are objected to.  
 8) Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

#### Application Papers

- 9) The specification is objected to by the Examiner.  
 10) The drawing(s) filed on \_\_\_\_\_ is/are: a) accepted or b) objected to by the Examiner.  
     Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
     Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  
 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

#### Priority under 35 U.S.C. § 119

- 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  
 a) All    b) Some \* c) None of:  
 1. Certified copies of the priority documents have been received.  
 2. Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.  
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

#### Attachment(s)

- |  |   |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892)          | 4) <input type="checkbox"/> Interview Summary (PTO-413)           |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ .                                    |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)          | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____.   | 6) <input type="checkbox"/> Other: _____ .                        |

**Continued Examination Under 37 CFR 1.114**

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 3/8/11 has been entered.
2. In light of the amendment filed 3/8/11, claims 1-11 and 13-17 have been canceled. Claims 12,18 and 19 remain in the application.
3. In light of the amendment filed 3/8/11, the 35 USC 103 rejections have been withdrawn, however, the following rejection has been necessitated by the amendment.
4. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
5. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later

invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

### **Claim Rejections - 35 USC § 103**

6. Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) both (a) or (b) in combination with Kikuchi et al. (4,704,002) further in combination with Yamazaki et al. (6,230,619).

Hattori et al. (5,403,616) teaches a method of forming patterned transparent conductive film. The patterning process comprises forming a masking pattern (2) on a substrate (10), applying the coating layer (3), heating the coating layer and the mask to set the coating layer and remove the mask to form the patterned layer (abstract, Figs. 1a-1e, 2a-2e and col. 2, line 60 – col. 3, line 65). Hattori et al. (5,403,616) teaches the process utilized for LCD devices (col. 1, lines 9-25). The glass substrate can have a coating of silica thereon prior to the application of the patterned coating layer (examples). The coating layer can be applied by spin coating, dip coating or roll coating (col. 4, lines 41-64). Hattori et al. (5,403,616) teaches physically removing the masking pattern by ultrasonic cleaning or gas jet of air (col. 4, lines 28-40).

Hattori et al. (5,403,616) fails to teach a master being separately formed and separable from the substrate.

JP 08-031,830 teaches a solder bump forming process whereby a mask is set with a distance above the substrate and solder is filled in the mask. The solder can be placed on the substrate by die punching (Figs. 1A-1D) or by being close enough to the substrate (Figs. 4A-4D).

Therefore, it would have been obvious for one skilled in the art at the time the invention was made to have modified Hattori et al. (5,403,616) process by substituting a "displaced mask" as evidenced by JP 08-031,830 for the mask of Hattori et al. (5,403,616) with the expectation of achieving similar success.

(a) Hattori et al. (5,403,616) in combination with JP 08-031,830 fail to teach a distance between the master and substrate being a few micrometers.

While this may be the case, it is the Examiner's position that the distance between the mask and the substrate would be a matter of design choice of one practicing in the art depending upon the desired end product. It is would be within the skill of one practicing in the art to separate the mask from the substrate at a "distance" equal to or slightly greater than the "height" of the paste being applied to assure placement upon the substrate. These parameters are "result effective variables" which are deemed as an unpatentable distinction over the art absent a showing of unexpected results.

(b) Hattori et al. (5,403,616) in combination with JP 08-031,830 fail to teach a distance between the master and substrate being a few micrometers.

Yamuni et al. (6,730,358) teaches a method for depositing conductive paste using stencil whereby a mask having a thickness of 0.001-0.008 microns being displaced from the substrate and the pins are about greater than 40% of the length of the aperture to from the coating (col. 4,

lines 32-40 and col. 6, lines 50-63). With this in mind the distance between the mask and the substrate must be equal to or less than the thickness of the mask and therefore meets the claimed invention. This is the same argument presented by applicant in the response filed 1/28/09, i.e. there is a correspondence between thickness of mask and distance between mask and substrate.

Therefore it would have been obvious for one skilled in the art at the time the invention was made to have modified Hattori et al. (5,403,616) in combination with JP 08-031,830 process to have a distance between the master and substrate being a few micrometers as evidenced by Yamuni et al. (6,730,358) with the expectation of achieving similar success.

Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) both fail to teach a stepped etching layer.

Features detailed above concerning Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) are incorporated here.

Kikuchi et al. (4,704,002) depicts and teaches a display panel having stepped portions whereby photomasks are utilized to form the layers (abstract, col. 2, line 40 – col. 3, line 25 and Figs. 10b-17b).

Therefore it would have been obvious for one skilled in the art at the time the invention was made to have modified Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) process to incorporate a stepped etching layer as evidenced by Kikuchi et al. (4,704,002) with the expectation of achieving similar success, i.e. a patterned layer for LCD and TFT manufacture.

Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) both (a) or (b) in combination with Kikuchi et al. (4,704,002) fail to teach a roll coated for filling material in mask and separating material within mask without any outer impact.

Yamazaki et al. (6,230,619) teaches a printing method and printing apparatus. Yamazaki et al. (6,230,619) teaches filling a mask with a coating material by using a roll coater (Figs. 12A-12B) and removing the filled coating material from the mask by induction heating to reduce the viscosity of the coating material thereby allowing it to be removed from the mask and placed on the substrate (Figs. 1A-1D, Abstract, col. 7, lines 2-33 and col. 16, line 65 – col. 17, line 10).

Therefor it would have been obvious for one skilled in the art at the time the invention was made to have modified Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Yamuni et al. (6,730,358) both (a) or (b) in combination with Kikuchi et al. (4,704,002) process by using a roll coated and heating material to remove coating within mask as evidenced by Yamazaki et al. (6,230,619) with the expectation of achieving similar success.

7. Claims 18-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hattori et al. (5,403,616) in combination with JP 08-031,830 (a) alone or (b) further in combination with Kikuchi et al. (4,704,002) further in combination with Yamazaki et al. (6,230,619) still further in combination with Peek (4,301,191).

Hattori et al. (5,403,616) in combination with JP 08-031, 830 (a) alone or (b) in combination with Kikuchi et al. (4,704,002) in combination with Yamazaki et al. (6,230,619) fail to teach the distance between the master and the substrate being from 1-9 microns.

Peek (4,301,191) teaches a method of forming conductors by applying the conductive material through a mask located a small distance from the substrate (abstract). Peek (4,301,191) teaches a distance between the mask and the substrate to be 2 microns (col. 4, lines 45-50 and col. 6, lines 35-45).

Therefore it would have been obvious at the time the invention was made to have modified Hattori et al. (5,403,616) in combination with JP 08-031, 830 (a) alone or (b) in combination with Kikuchi et al. (4,704,002) in combination with Yamazaki et al. (6,230,619) process to position the mask at a distance of 2 microns as evidenced by Peek (4,301,191) with the expectation of achieving similar success, i.e. a pattern coating.

### **Response to Amendment**

8. Applicant's arguments with respect to claims 12,18 and 19 have been considered but are not found persuasive.

Applicant argued that the prior art fails to teach roll coated for filling material in mask and separating material within mask without any outer impact.

Yamazaki et al. (6,230,619) teaches this limitation as detailed above.

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9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Brian K. Talbot whose telephone number is (571) 272-1428. The examiner can normally be reached on Monday-Friday 8AM-4PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Timothy H. Meeks can be reached on (571) 272-1423. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Brian K Talbot/  
Primary Examiner, Art Unit 1715

BKT

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